MOSFET – Power, Single, P-Channel, SOT-23 -60 V, -211 mA

Features

- Trench Technology
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Small Signal Load Switch
- Analog Switch

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	-60	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	-196	mA	
Current (Note 1)		$T_A = 85^{\circ}C$		-141		
	t≤5 s	$T_A = 25^{\circ}C$		-211		
		$T_A = 85^{\circ}C$		-152		
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	347	mW	
	t ≤ 5 s			403		
Pulsed Drain Current	t _p =	= 10 μs	I _{DM}	-784	mA	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C	
Source Current (Body Diode) (Note 2)			I _S	-347	mA	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit	
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	360	°C/W	
Junction-to-Ambient – $t \le 5 s$ (Note 1)	$R_{\theta JA}$	310	°C/W	

1. Surface-mounted on FR4 board using 1 in. sq. pad size (Cu area - 1.127 in. sq. [2 oz.] including traces).

 Surface-mounted on FR4 board using the minimum recommended pad size of 30 mm2, 2 oz. Cu pad.

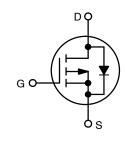


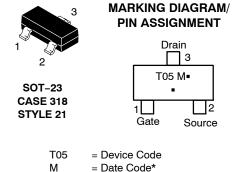
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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
–60 V	5Ω@–10V	–211 mA
	6 Ω @ –4.5 V	







= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR5105PT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

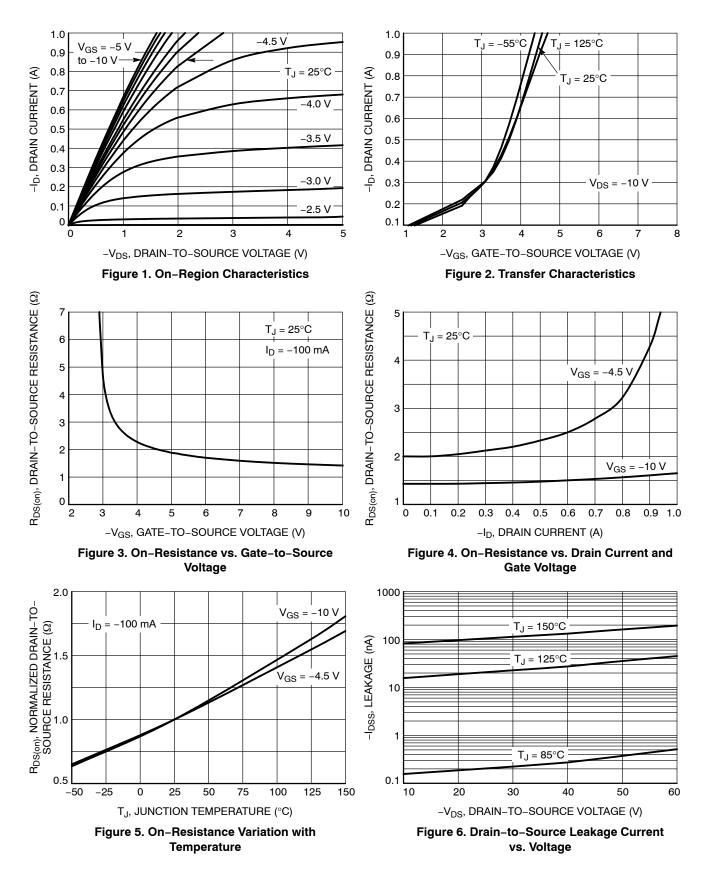
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

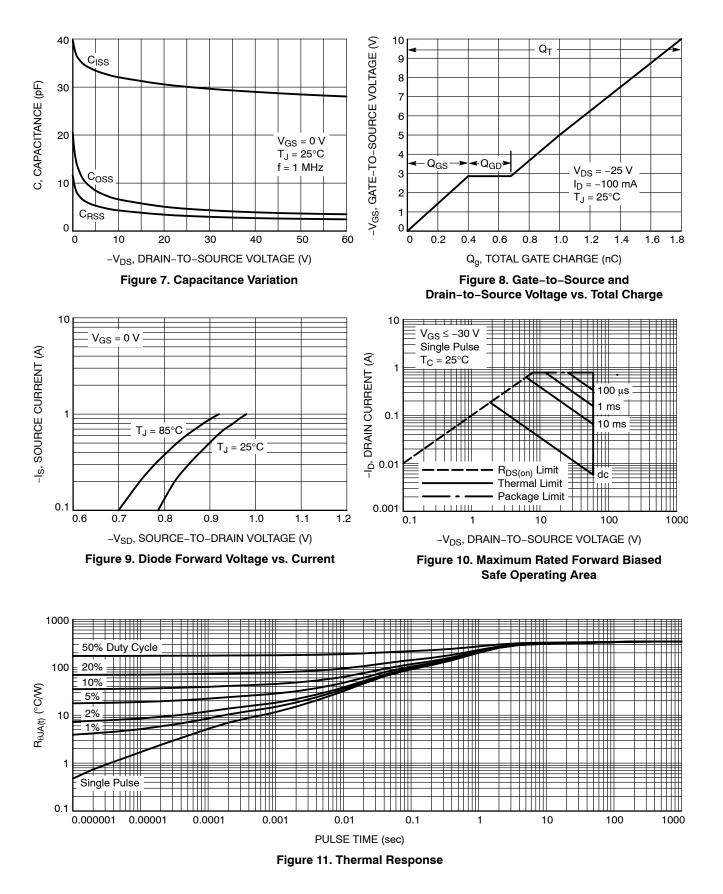
Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = -250 μ A		-60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	Reference to 25°C, $I_D = -250 \ \mu A$			6.5		mV/°C
Zero Gate Voltage Drain Current	$I_{DSS} \qquad \begin{array}{c} V_{GS} = 0 \text{ V}, \\ V_{DS} = -60 \text{ V} \end{array}$	$T_J = 25^{\circ}C$			-1.0	μA	
		V _{DS} = -60 V	T _J = 125°C			-10	1
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$				±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I	_D = -250 μA	-1.0		-3.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.2		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	$V_{GS} = -10 \text{ V}, \text{ I}_D = -100 \text{ mA}$ $V_{GS} = -4.5 \text{ V}, \text{ I}_D = -100 \text{ mA}$			1.6	5.0	Ω
					2.2	6.0	
Forward Transconductance	9 _{FS}	V _{DS} = -5.0 V, I _D = -100 mA			227		mS
CHARGES, CAPACITANCES & GATE	RESISTANCE	E					
Input Capacitance	C _{iss}				30.3		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -25 V			4.7		1
Reverse Transfer Capacitance	C _{rss}	• DS =	20 1		3.2		
Total Gate Charge	Q _{G(TOT)}				1.0		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = -5 V, V	√ns = −25 V.		0.2		
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = -100 \text{ mA}$			0.4		1
Gate-to-Drain Charge	Q _{GD}				0.3		
SWITCHING CHARACTERISTICS (No	ote 4)						
Turn-On Delay Time	t _{d(on)}	V_{GS} = –5 V, V_{DD} = –48 V, I_{D} = –100 mA, R_{G} = 1 Ω			5.8		ns
Rise Time	t _r				4.0		
Turn-Off Delay Time	t _{d(off)}				8.8		
Fall Time	t _f				12.8		1
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.78	1.0	V
		$I_{\rm S} = -100 \rm{mA}$	T⊥ = 125°C		0.59		

 $T_J = 125^{\circ}C$ 0.59 Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS







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